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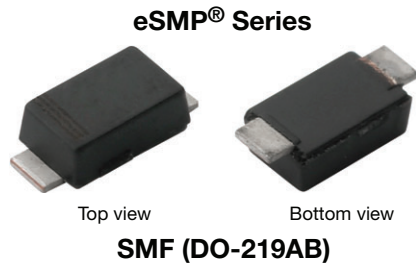
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## Surface-Mount Standard Rectifiers



### FEATURES

- Low profile package
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

AUTOMOTIVE  
GRADE  
Available



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0 A
$V_{RRM}$	200 V, 400 V, 600 V
$I_{FSM}$	35 A
$V_F$ at $I_F = 2.0$ A ( $T_A = 125$ °C)	0.85 V
$I_R$	5 $\mu$ A
$T_J$ max.	175 °C
Package	SMF (DO-219AB)
Circuit configuration	Single

### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in commercial, industrial, and automotive applications.

### MECHANICAL DATA

**Case:** SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - for, halogen-free, and RoHS-compliant

Base P/NHM3 - for halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes the cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)					
PARAMETER	SYMBOL	SE20FD	SE20FG	SE20FJ	UNIT
Device marking code		CD	CG	CJ	
Maximum repetitive peak reverse voltage	$V_{RRM}$	200	400	600	V
Maximum DC forward current	$I_{F(AV)}$ <sup>(1)</sup>	2.0			A
	$I_{F(AV)}$ <sup>(2)</sup>	1.7			
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	35			A
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +175			°C

#### Notes

(1) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 2.0\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.96	1.10	V
		$T_A = 125\text{ }^\circ\text{C}$		0.85	1.00	
Reverse current	Rated $V_R$	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	5	$\mu\text{A}$
		$T_A = 125\text{ }^\circ\text{C}$		7.6	100	
Typical reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$		$t_{rr}$	920	-	ns
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	13	-	pF

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
(2) Pulse test: Pulse width  $\leq 40\text{ ms}$

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	SE20FD	SE20FG	SE20FJ	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	130			$^\circ\text{C/W}$
	$R_{\theta JM}^{(1)}$	20			

**Note**

- (1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount

<b>IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}, R = 1.5\text{ k}\Omega$	$V_C$	H3B	$> 8\text{ kV}$

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE20FJ-M3/H	0.015	H	3000	7" diameter plastic tape and reel
SE20FJ-M3/I	0.015	I	10 000	13" diameter plastic tape and reel
SE20FJHM3/H <sup>(1)</sup>	0.015	H	3000	7" diameter plastic tape and reel
SE20FJHM3/I <sup>(1)</sup>	0.015	I	10 000	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified





RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

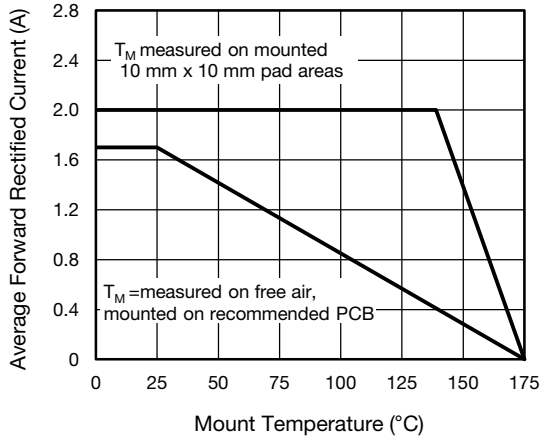


Fig. 1 - Maximum Forward Current Derating Curve

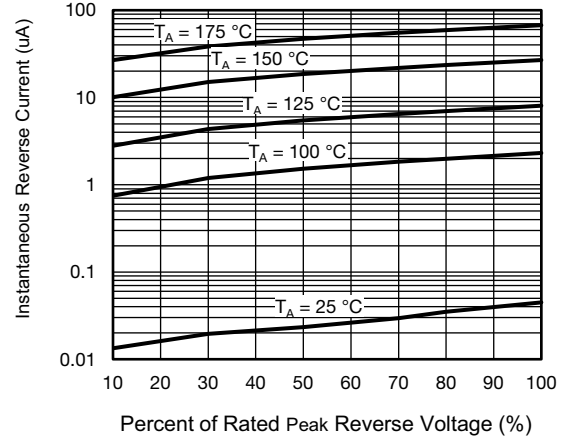


Fig. 4 - Typical Reverse Leakage Characteristics

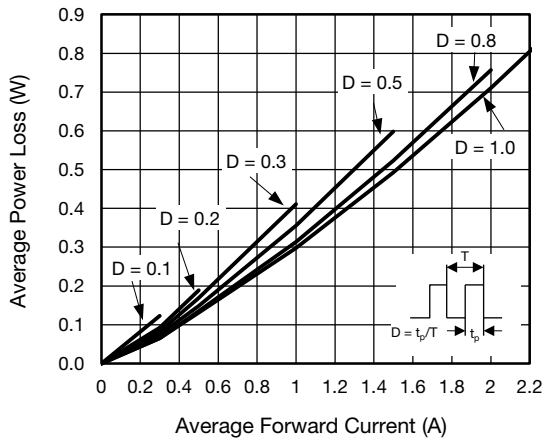


Fig. 2 - Average Power Loss Characteristics

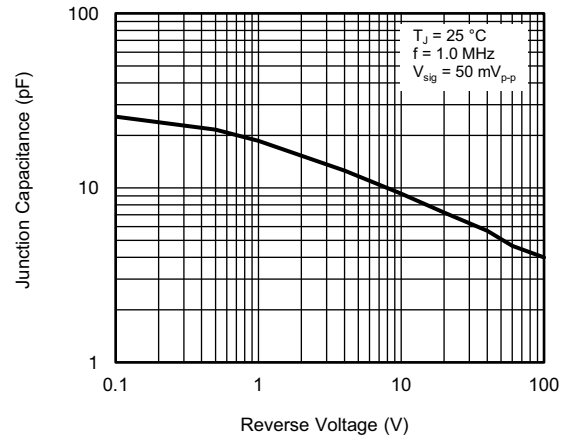


Fig. 5 - Typical Junction Capacitance

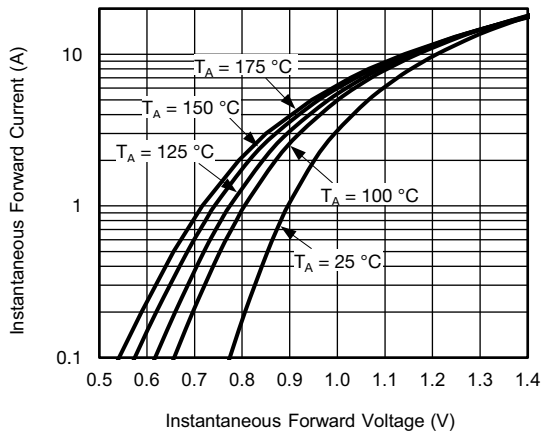


Fig. 3 - Typical Instantaneous Forward Characteristics

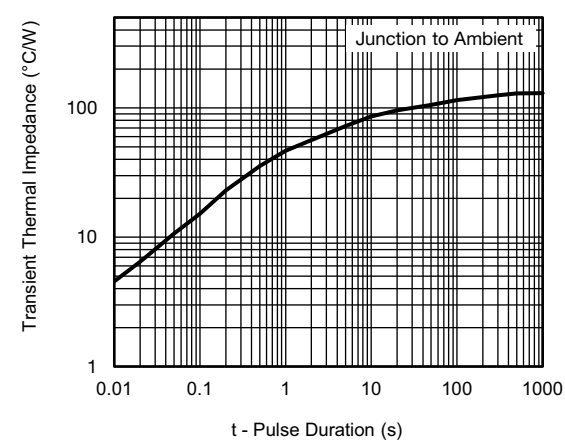
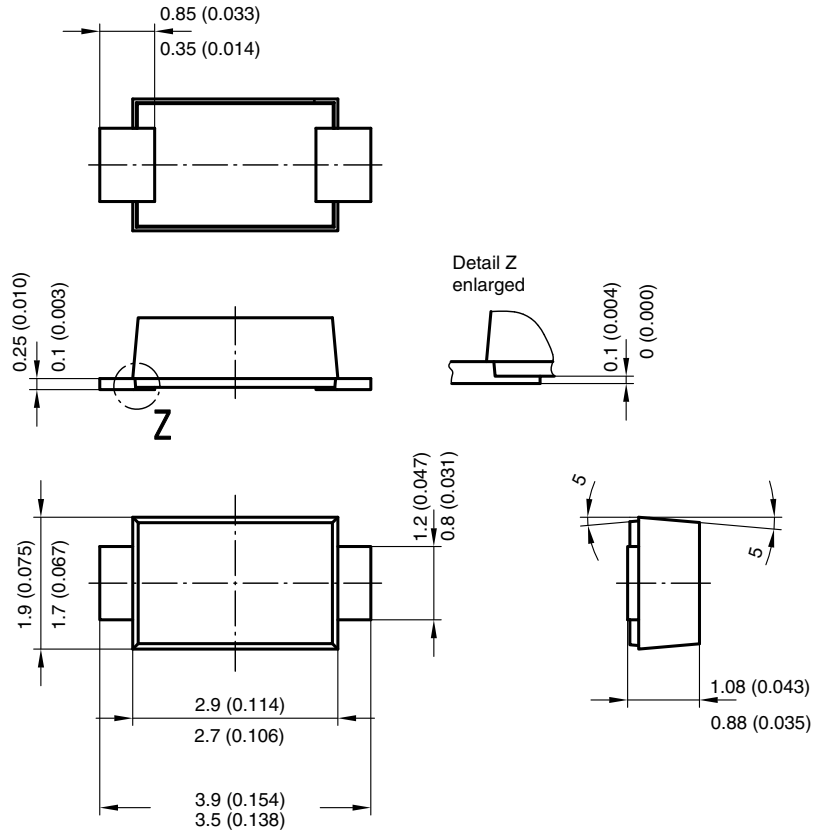


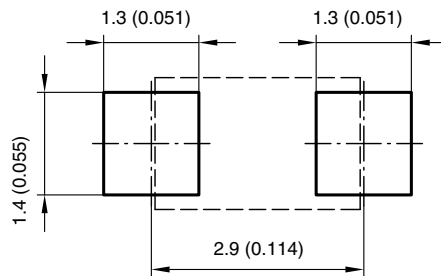
Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



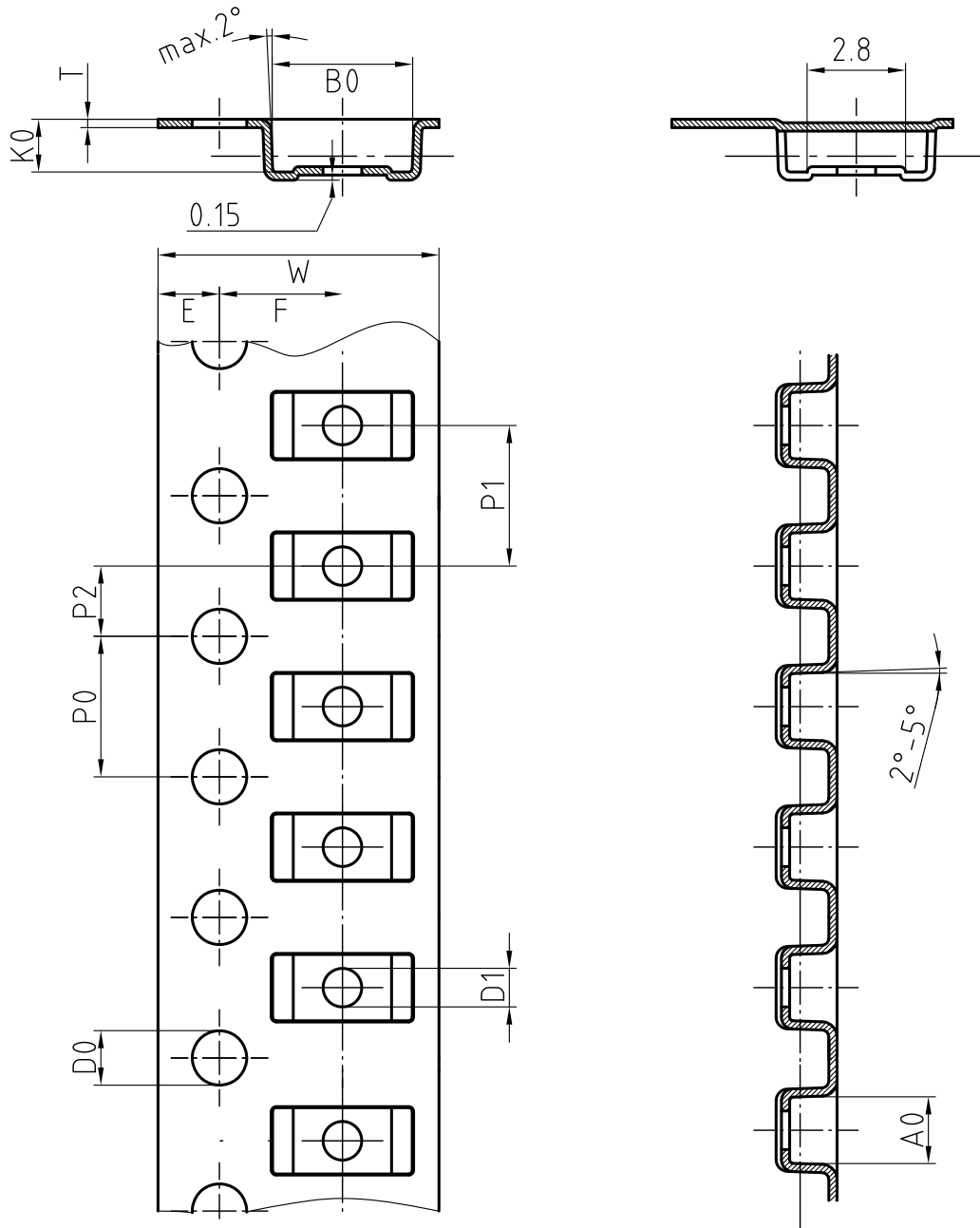
Foot print recommendation:



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 Rev. 3 - Date: 13. March 2007  
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 17247



**BLISTERTAPE DIMENSIONS** in millimeters: **SMF (DO-219AB)**



Mat:	A0	B0	K0	W	T	P0	P2	P1	D0	D1	E	F
PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

Document-No.: S8-V-3717.02-001 (3)

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